

# **PHOTOCOUPLER**

# PS2801A-1,PS2801A-4

# HIGH ISOLATION VOLTAGE SSOP PHOTOCOUPLER

-NEPOC Series-

#### **DESCRIPTION**

The PS2801A-1 and PS2801A-4 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor in a plastic SSOP for high density applications to realize an excellent cost performance.

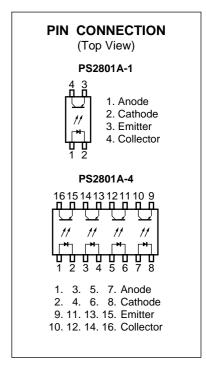
This package has shield effect to cut off ambient light.

#### **FEATURES**

- · Lead-free product: Solder plating specification Sn-Bi
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4, 16-pin SSOP, Pin pitch 1.27 mm)
- Ordering number of tape product: PS2801A-1-F3, F4, PS2801A-4-F3, F4
- · Safety standards
  - UL approved: File No. E72422
  - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

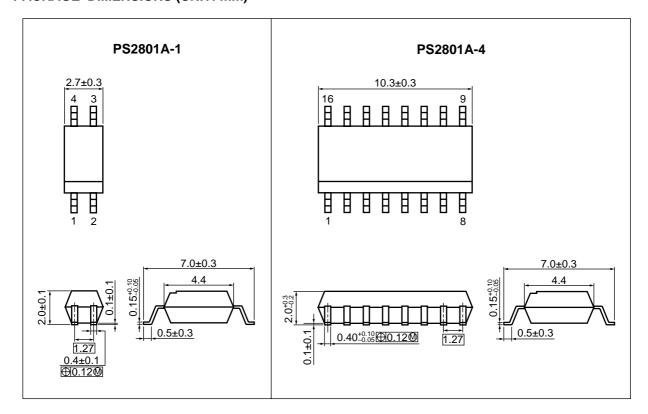
#### **APPLICATIONS**

- · Programmable logic controllers
- · Measuring instruments
- Power supply
- Hybrid IC

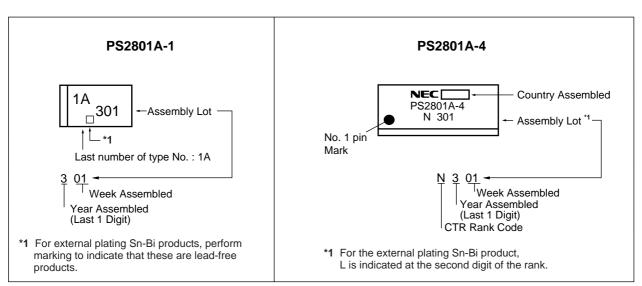


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# PACKAGE DIMENSIONS (UNIT: mm)



# **MARKING EXAMPLE**





# ORDERING INFORMATION

Part Number	Package	Packing Style	Safety Standards Approval	Solder Plating Specification	Application Part Number*1
PS2801A-1	4-pin SSOP	50 pcs (Tape 50 pcs cut)	Standard products	Sn-Pb	PS2801A-1
PS2801A-1-F3		Embossed Tape 3 500 pcs/reel	(UL approved)		
PS2801A-1-F4					
PS2801A-4	16-pin SSOP	Magazine Case 45 pcs			PS2801A-4
PS2801A-4-F3		Embossed Tape 2 500 pcs/reel			
PS2801A-4-F4					
PS2801A-1-V	4-pin SSOP	50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2		PS2801A-1
PS2801A-1-F3-V		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)		
PS2801A-1-F4-V			Approved (Option)		
PS2801A-4-V	16-pin SSOP	Magazine Case 45 pcs			PS2801A-4
PS2801A-4-F3-V		Embossed Tape 2 500 pcs/reel			
PS2801A-4-F4-V					
PS2801A-1-A	4-pin SSOP	50 pcs (Tape 50 pcs cut)	Standard products	Sn-Bi	PS2801A-1
PS2801A-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)		
PS2801A-1-F4-A					
PS2801A-4-A	16-pin SSOP	Magazine Case 45 pcs			PS2801A-4
PS2801A-4-F3-A		Embossed Tape 2 500 pcs/reel			
PS2801A-4-F4-A					
PS2801A-1-V-A	4-pin SSOP	50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2		PS2801A-1
PS2801A-1-F3-V-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)		
PS2801A-1-F4-V-A			Approved (Option)		
PS2801A-4-V-A	16-pin SSOP	Magazine Case 45 pcs			PS2801A-4
PS2801A-4-F3-V-A		Embossed Tape 2 500 pcs/reel			
PS2801A-4-F4-V-A					

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

# ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2801A-1	PS2801A-4	
Diode	Forward Current (DC)	lF	3	mA	
	Reverse Voltage	Vr	6		V
	Power Dissipation Derating	⊿P₀/°C	0.6	0.8	mW/°C
	Power Dissipation	PD	60	80	mW/ch
	Peak Forward Current <sup>™</sup>	IFP	0.5		Α
Transistor	Collector to Emitter Voltage	Vceo	70		V
	Emitter to Collector Voltage	VECO	Ę	5	V
	Collector Current	lc	3	0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1.2		mW/°C
	Power Dissipation	Pc	120		mW/ch
Isolation Voltage <sup>2</sup>		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100		°C
Storage Temperature		T <sub>stg</sub>	-55 to +150		°C

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1 %

<sup>\*2</sup> AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output

# **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I <sub>F</sub> = 5 mA		1.2	1.4	V
	Reverse Current	lR	V <sub>R</sub> = 5 V			5	μΑ
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		10		pF
Transistor	Collector to Emitter Dark Current	Iceo	Vce = 70 V, Ir = 0 mA			100	nA
Coupled	Current Transfer Ratio	CTR	IF = 5 mA, VcE = 5 V	50		400	%
	Collector Saturation Voltage	VCE(sat)	I <sub>F</sub> = 10 mA, I <sub>C</sub> = 2 mA		0.13	0.3	V
	Isolation Resistance	R <sub>I-O</sub>	Vi-o = 1.0 kVpc	10 <sup>11</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time <sup>*2</sup>	<b>t</b> r	Vcc = 5 V, Ic = 2 mA, RL = 100 $\Omega$		5		μs
	Fall Time 2	<b>t</b> f			7		

# \*1 CTR rank

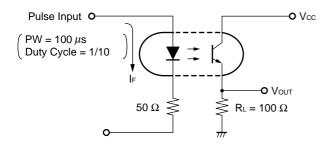
# PS2801A-1

N: 50 to 400 (%) P: 150 to 300 (%) L: 100 to 300 (%)

# PS2801A-4

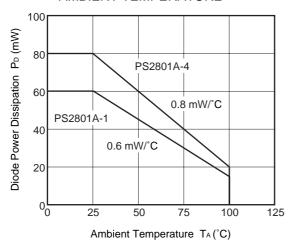
N: 50 to 400 (%)

# \*2 Test circuit for switching time

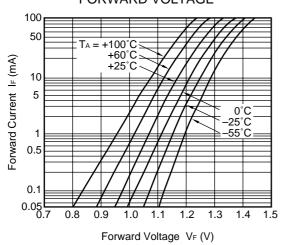


#### TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)

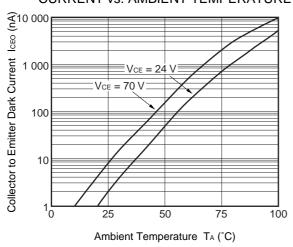
# DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



FORWARD CURRENT vs. FORWARD VOLTAGE

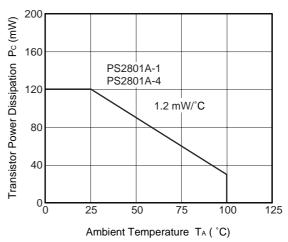


**COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE** 

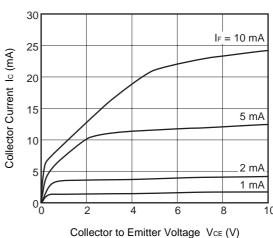


Remark The graphs indicate nominal characteristics.

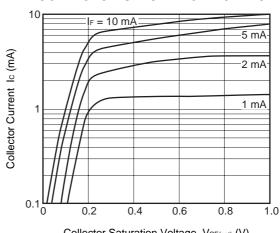
#### TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



# COLLECTOR CURRENT vs. **COLLECTOR TO EMITTER VOLTAGE**

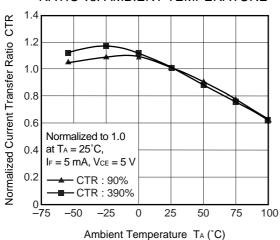


#### COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**

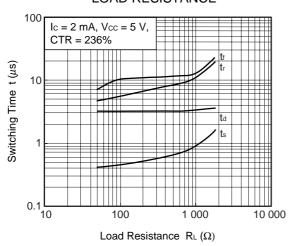


Collector Saturation Voltage VcE(sat) (V)

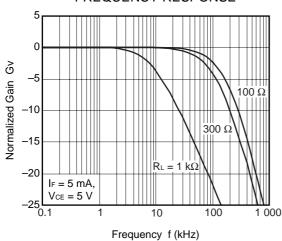
# NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



# SWITCHING TIME vs. LOAD RESISTANCE

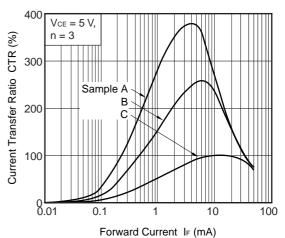


# FREQUENCY RESPONSE

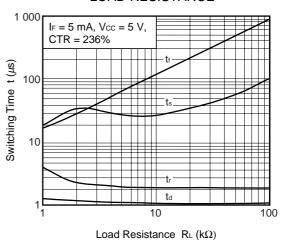


#### Remark The graphs indicate nominal characteristics.

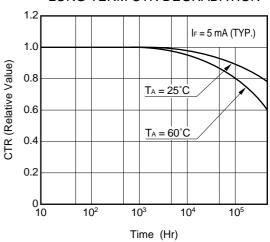
# CURRENT TRANSFER RATIO vs. FORWARD CURRENT



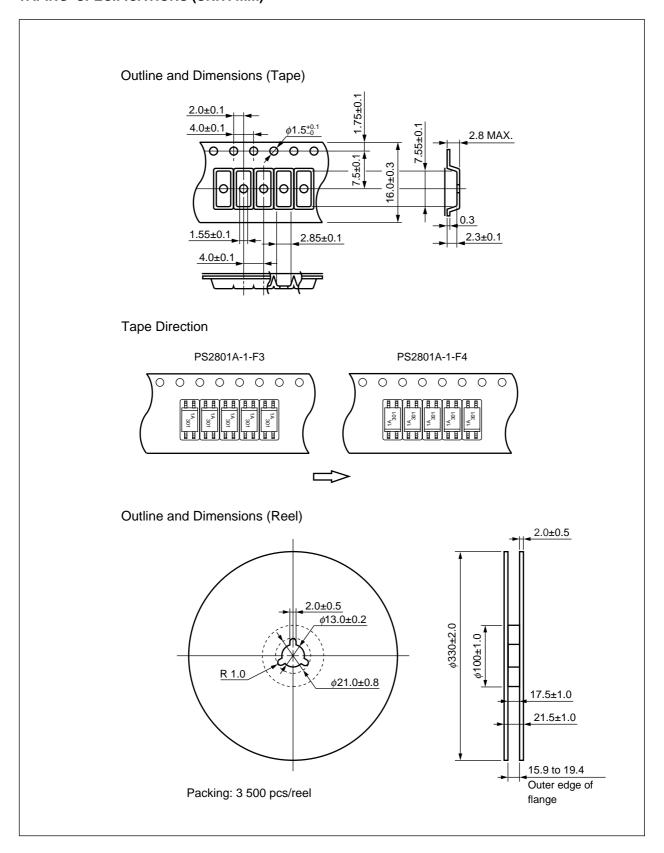
# SWITCHING TIME vs. LOAD RESISTANCE

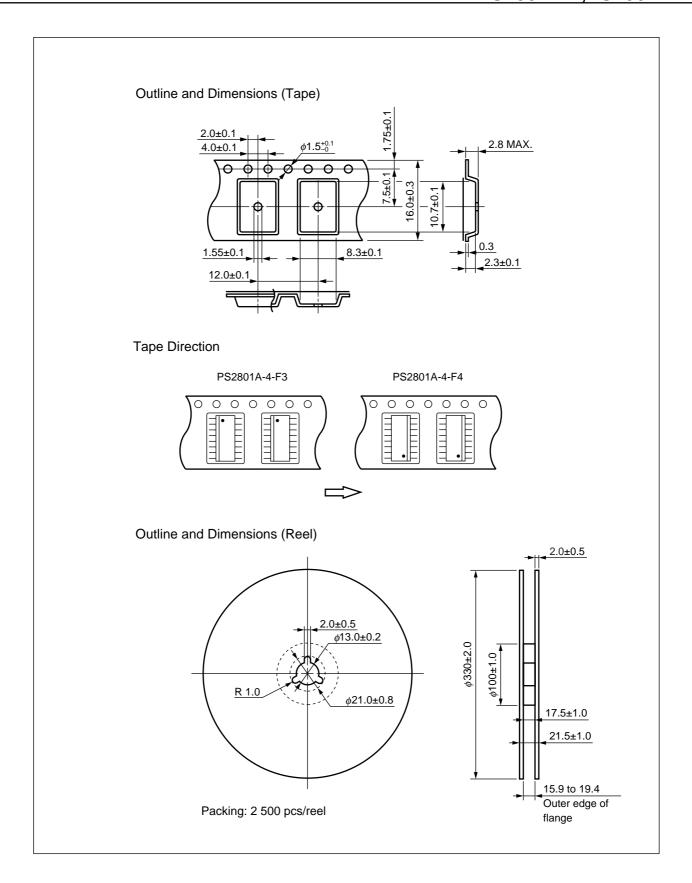


#### LONG TERM CTR DEGRADATION



# TAPING SPECIFICATIONS (UNIT: mm)





#### **NOTES ON HANDLING**

#### 1. Recommended soldering conditions

#### (1) Infrared reflow soldering

· Peak reflow temperature 260°C or below (package surface temperature)

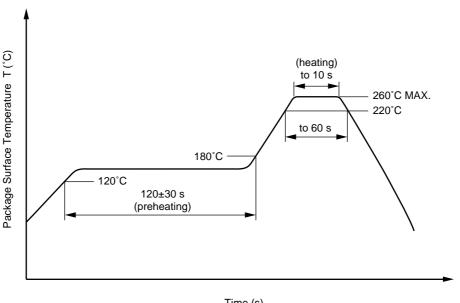
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

#### (3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

# (4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

# 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

#### **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- **2.** Avoid storage at a high temperature and high humidity.

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M8E 00.4-0110

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

#### ▶ For further information, please contact

#### NEC Compound Semiconductor Devices, Ltd. http://www.ncsd.necel.com/

E-mail: salesinfo@ml.ncsd.necel.com (sales and general) techinfo@ml.ncsd.necel.com (technical)

5th Sales Group, Sales Division TEL: +81-44-435-1588 FAX: +81-44-435-1579

#### **NEC Compound Semiconductor Devices Hong Kong Limited**

E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

# NEC Electronics (Europe) GmbH http://www.ee.nec.de/

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

#### California Eastern Laboratories, Inc. http://www.cel.com/

TEL: +1-408-988-3500 FAX: +1-408-988-0279